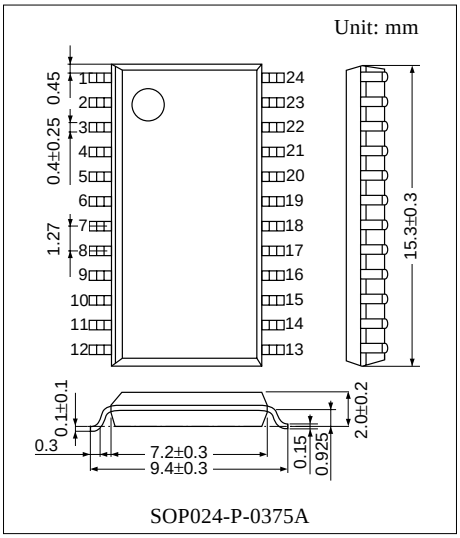
AN5829S

Sound multiplex decoder IC for the U.S. televisions

■ Overview

The AN5829S is a multiplex sound demodulation IC dedicated to the U.S. television and incorporates a bi-directional I^2C interface (adjustment, mode SW), an AGC circuit and external stereo input switches (2 systems).



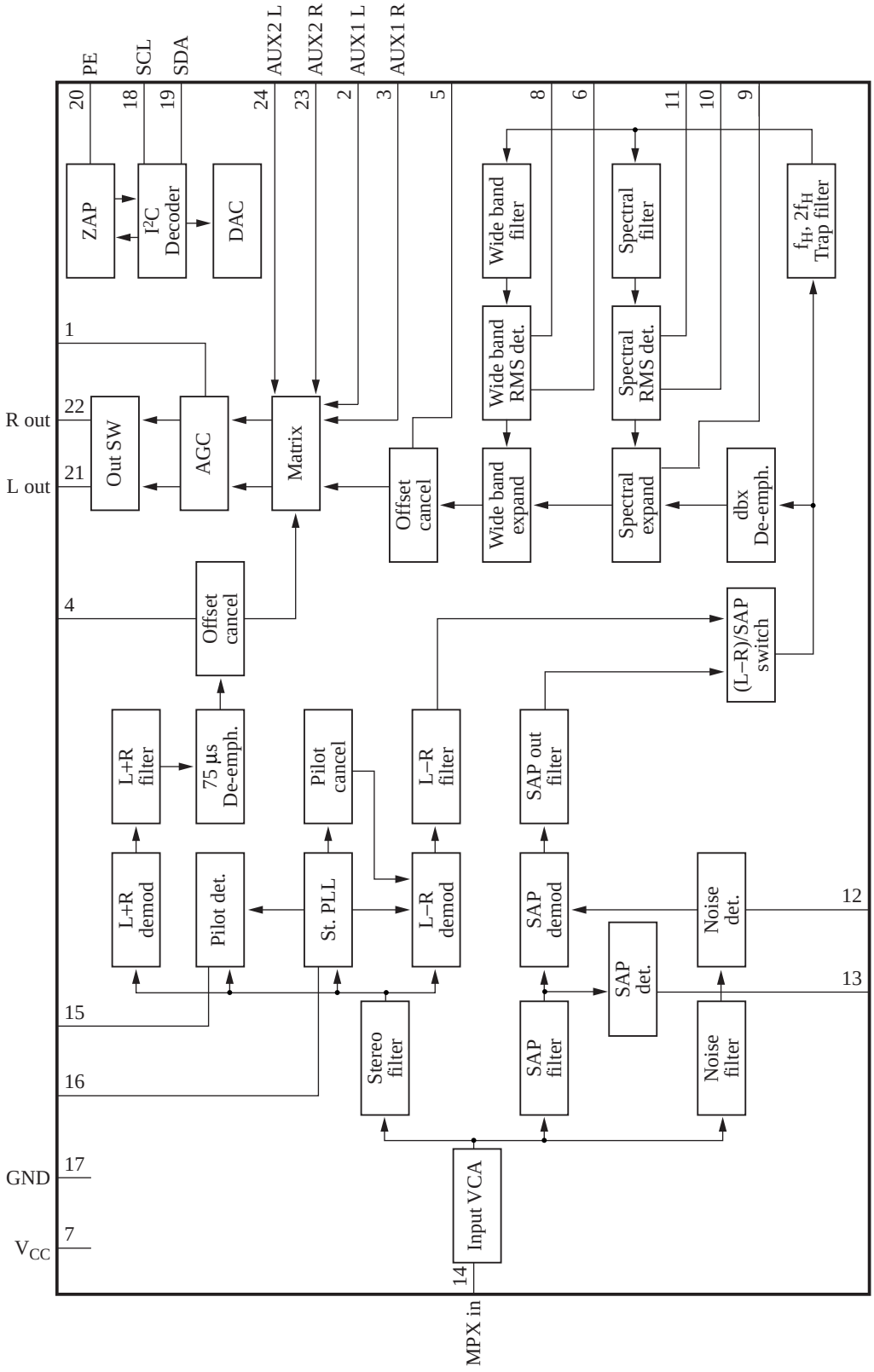
■ Features

- Stereo demodulation, SAP demodulation, dbx noise reduction, AGC, external stereo input SW and I^2C bus interface are integrated in a single chip
- Bi-directional I^2C bus makes it possible to monitor MPX input level, separation adjustment (3 places), mode changeover and receiving status.
- Eliminated external parts (multi-sound block: 21 pieces $\rightarrow$ 14 pieces
- Lower power dissipation (V_{CC} = 5 V, I_{TOT} = 18 mA)

■ Applications

- Televisions and VCRs for the North American market

■ Block Diagram



■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	AGC timing	13	SAP carrier detection
2	External input 1 L-ch	14	Composite input
3	External input 1 R-ch	15	Pilot signal detection
4	75 µs filter offset cancel	16	Stereo PLL filter
5	dbx offset cancel	17	GND
6	Wideband timing	18	SCL
7	V_{CC}	19	SDA
8	Wideband level sensor input	20	PE for ZAP
9	Spectral filter	21	L-ch output
10	Spectral timing	22	R-ch output
11	Spectral level sensor input	23	External input 2 R-ch.
12	SAP noise level detection	24	External input 2 L-ch.

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V_{CC}	6.0	V
Supply current	I_{CC}	25	mA
Power dissipation *2	P_D	150	mW
Operating ambient temperature *1	T_{opr}	−20 to +75	°C
Storage temperature *1	T_{stg}	−55 to +125	°C

Note) The use of this IC, which builds in dbx-TV noise reduction, requires a license agreement with THAT Corporation.

∗1: Except fot the operating ambient temperature and storage temperature, all ratings are for T_a = 25°C.

∗2: T_a = 75°C

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V_{CC}	4.5 to 5.5	V

■ Electrical Characteristics at V_{CC} = 5 V, NR: On, T_a = 25°C

Input level (at 100% modulation) L+R: 75 mV[rms] (pre-emphasis off)
L−R: 150 mV[rms] (dbx noise reduction off)
Pilot: 15 mV[rms]
SAP: 45 mV[rms] (dbx noise reduction off)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Total circuit current	I_{CC}	No signal	11	18	25	mA
Mono output level	$V_{0(MON)}$	f = 1 kHz, (mono) 100%mod	430	480	530	mV[rms]
Mono frequency characteristics-1	$V_{1(MON)}$	f = 300 Hz, (mono) 30%mod	− 0.5	0	0.5	dB
Mono frequency characteristics-2	$V_{2(MON)}$	f = 8 kHz, (mono) 30%mod	−1.2	− 0.1	0.7	dB
Mono distortion ratio	$THD_{(MON)}$	f = 1 kHz, (mono) 100%mod	—	—	0.7	%
Mono noise level	$V_{N(MON)}$	Input short-circuit, BPF (A curve)	—	—	−60	dBV
(L), (R) output voltage difference	$V_{LR(MON)}$	f = 1 kHz, (mono) 100%mod	− 0.5	0	0.5	dB
Stereo output level	$V_{0(ST)}$	f = 1 kHz, (L(R)-only) 100%mod	380	480	580	mV[rms]
Stereo frequency characteristics-1	$V_{1(ST)}$	f = 300 Hz, (L(R)-only) 30%mod	− 0.7	0	0.7	dB
Stereo frequency characteristics-2	$V_{2(ST)}$	f = 3 kHz, (L(R)-only) 30%mod	−1	0	1	dB
Stereo frequency characteristics-3	$V_{3(ST)}$	f = 8 kHz, (L(R)-only) 30%mod	−2.5	− 0.5	1.5	dB
Stereo distortion ratio	$THD_{(ST)}$	f = 1 kHz, (L(R)-only) 100%mod	—	—	1	%
Stereo noise level	$V_{N(ST)}$	f = 15.73 kHz, (f_H), 15 mV[rms] f_H, 2 f_H Trap+BPF	—	—	−60	dBV
Stereo discrimination level	$V_{TH(ST)}$	f = 15.73 kHz (f_H)	4	8	13	mV[rms]
Stereo discrimination hysteresis	$V_{HY(ST)}$	f = 15.73 kHz (f_H)	0.5	—	5	dB
SAP output level	$V_{0(SAP)}$	f = 1 kHz, (SAP) 100%mod	370	500	680	mV[rms]
SAP frequency characteristics-1	$V_{1(SAP)}$	f = 300 Hz, (SAP) 30%mod	−1	0	1	dB
SAP frequency characteristics-2	$V_{2(SAP)}$	f = 3 kHz, (SAP) 30%mod	−2.5	− 0.5	1	dB
SAP distortion ratio	$THD_{(SAP)}$	f = 1 kHz, (SAP) 100%	—	—	1.5	%
SAP noise level	$V_{N(SAP)}$	f = 78.7 kHz, ($5f_H$),V= 45 mV[rms], BPF	—	—	−70	dBV
SAP discrimination level	$V_{TH(SAP)}$	f = 78.7 kHz, ($5f_H$)	11	—	26	mV[rms]
SAP discrimination hysteresis	$V_{HY(SAP)}$	f = 78.7 kHz, ($5f_H$)	0.5	—	5	dB
SAP → Stereo crosstalk	C_{T1}	(SAP)1 kHz, 100%mod (Stereo) pilot-signal	—	—	−50	dB
Stereo → SAP crosstalk	C_{T2}	(Stereo) 1 kHz, 100%mod (SAP) carrier-signal	—	—	−50	dB
SAP → Mono crosstalk	C_{T3}	(SAP) 1 kHz, 100%mod	—	—	−50	dB
Mono → SAP crosstalk	C_{T4}	(Mono) 1 kHz, 100%mod (SAP) carrier-signal	—	—	−56	dB
AUX 1, AUX 2 to INT crosstalk	C_{T5}	f = 1 kHz, V_{IN} = 500 mV[rms]	—	—	50	dB
INT, AUX 2 to AUX 1 crosstalk	C_{T6}	INT: (mono) 1 kHz, 100%mod EXT: f = 1 kHz, 500 mV[rms]	—	—	50	dB
INT, AUX 1 to AUX 2 crosstalk	C_{T7}	INT: (mono) 1 kHz, 100%mod EXT: f = 1 kHz, 500 mV[rms]	—	—	50	dB

■ Electrical Characteristics at V_{CC} = 5 V, NR: On, T_a = 25°C (continued)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
AGC gain 1*1	V_{AGC1}	f = 1 kHz, $V_{IN(EXT)}$ = 50 mV[rms]	67	100	140	mV[rms]
AGC gain 2 *1	V_{AGC2}	f = 1 kHz, $V_{IN(EXT)}$ = 500 mV[rms]	180	270	390	mV[rms]
I² C interface						
Sink current at ACK	I_{ACK}	Maximum pin 2 sink current at ACK	1	2	20	mA
SCL, SDA signal input high level	V_{IHI}	—	3.5	—	5.0	V
SCL, SDA signal input low level	V_{ILO}	—	0	—	0.9	V
Input available maximum frequency	f_{Imax}	—	—	—	100	kbit/s

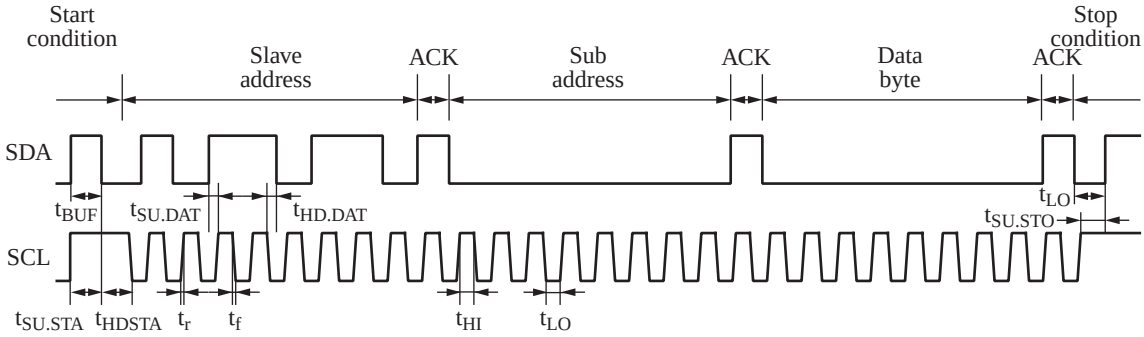
Note) ∗1: 00H register: D7 = 0, D6 = 1

• Design reference data

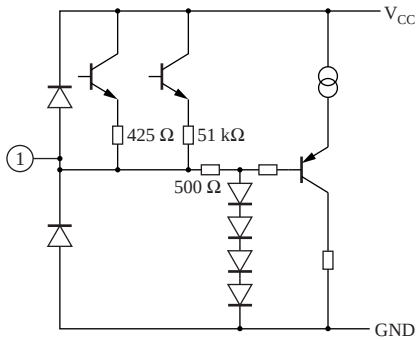
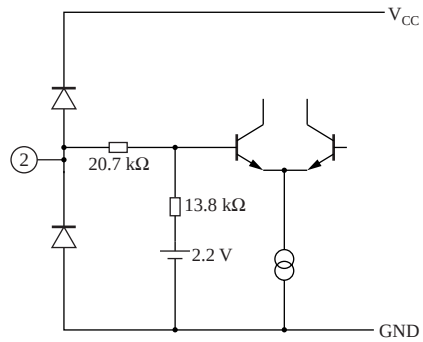
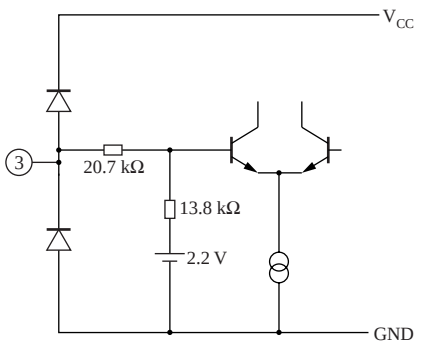
Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Stereo separation (100%)-1	Sep_{100-1}	f = 300 Hz, (L(R)-only) 100%mod	20	35	—	dB
Stereo separation (100%)-2	Sep_{100-2}	f = 1 kHz, (L(R)-only) 100 %mod	17	28	—	dB
Stereo separation (100%)-3	Sep_{100-3}	f = 3 kHz, (L(R)-only) 100%mod	20	35	—	dB
Stereo separation (100%)-4	Sep_{100-4}	f = 8 kHz, (L(R)-only) 100%mod	10	18	—	dB
Stereo separation (30%)-1	Sep_{30-1}	f = 300 Hz, (L(R)-only) 30%mod	22	35	—	dB
Stereo separation (30%)-2	Sep_{30-2}	f = 1 kHz, (L(R)-only) 30%mod	20	35	—	dB
Stereo separation (30%)-3	Sep_{30-3}	f = 3 kHz, (L(R)-only) 30%mod	22	35	—	dB
Stereo separation (30%)-4	Sep_{30-4}	f = 8 kHz, (L(R)-only) 30%mod	14	22	—	dB
Stereo separation (10%)-1	Sep_{10-1}	f = 300 Hz, (L(R)-only) 10%mod	20	35	—	dB
Stereo separation (10%)-2	Sep_{10-2}	f = 1 kHz, (L(R)-only) 10%mod	20	35	—	dB
Stereo separation (10%)-3	Sep_{10-3}	f = 3 kHz, (L(R)-only) 10%mod	20	30	—	dB
Stereo separation (10%)-4	Sep_{10-4}	f = 8 kHz, (L(R)-only) 10%mod	14	22	—	dB
I² C interface						
Bus free before start	t_{BUF}	—	4.0	—	—	µs
Start condition set-up time	$t_{SU.STA}$	—	4.0	—	—	µs
Start condition hold time	$t_{HD.STA}$	—	4.0	—	—	µs
Low period SCL, SDA	t_{LO}	—	4.0	—	—	µs
High period SCL	t_{HI}	—	4.0	—	—	µs
Rise time SCL, SDA	t_r	—	—	—	1.0	µs
Fall time SCL, SDA	t_f	—	—	—	0.35	µs
Data set-up time (write)	$t_{SU.DAT}$	—	0.25	—	—	µs
Data hold time (write)	$t_{HD.DAT}$	—	0.3	—	—	µs
Acknowledge set-up time	$t_{SU.ACK}$	—	—	—	3.5	µs
Acknowledge hold time	$t_{HD.ACK}$	—	0	—	—	µs
Stop condition set-up time	$t_{SU.STO}$	—	4.0	—	—	µs

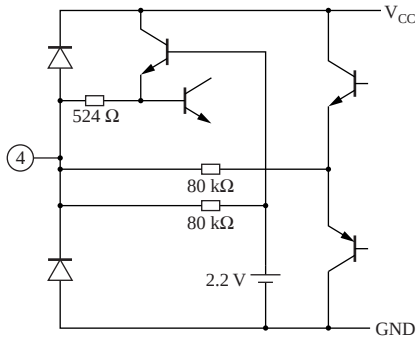
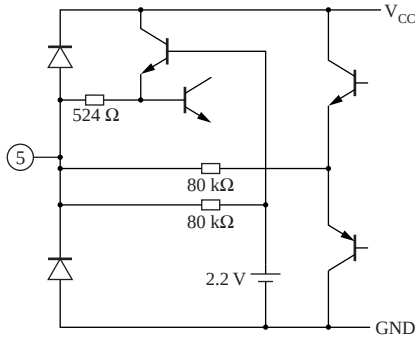
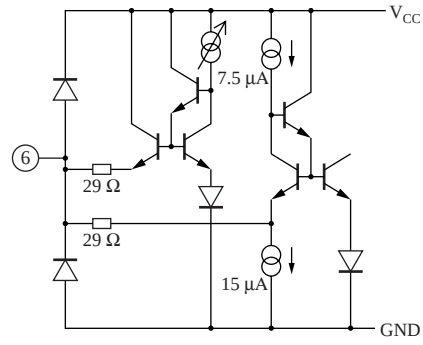
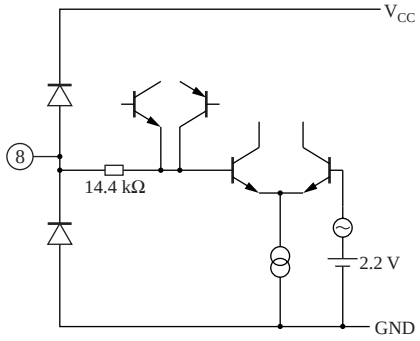
■ Electrical Characteristics at V_{CC} = 5 V, NR: On, T_a = 25°C (continued)



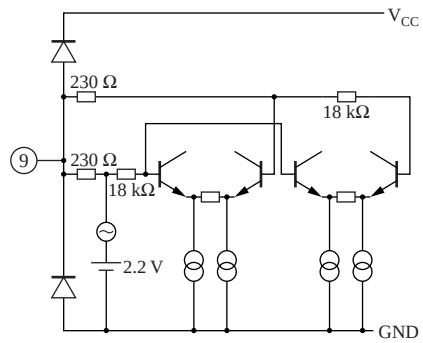
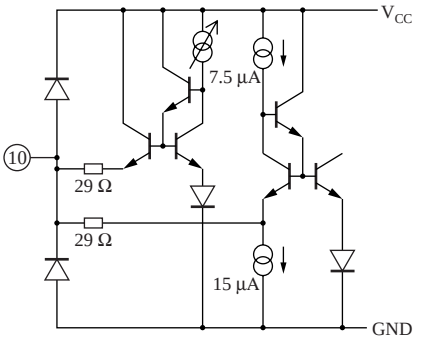
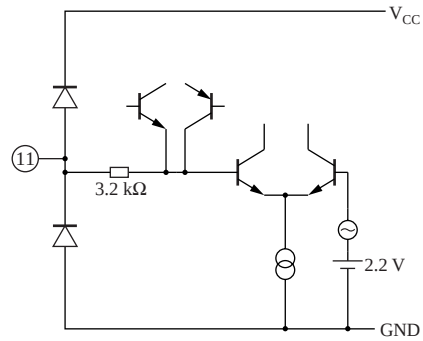
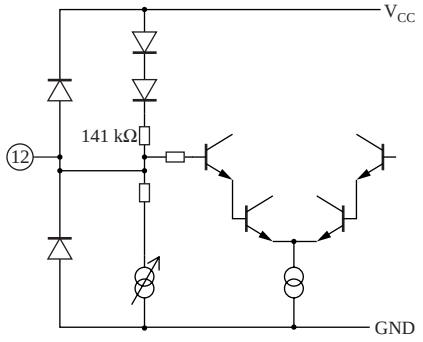
■ Terminal Equivalent Circuits

Pin No.	Equivalent circuit	Description	DC voltage (V)
1		AGC: AGC level sensor pin	0.5 to 2.0
2		AUXIL: External input1 L-ch input pin	2.2
3		AUXIR: External input 1 R-ch input pin	2.2

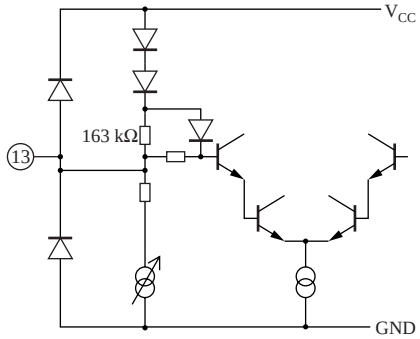
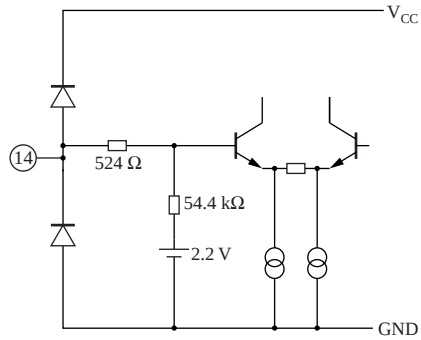
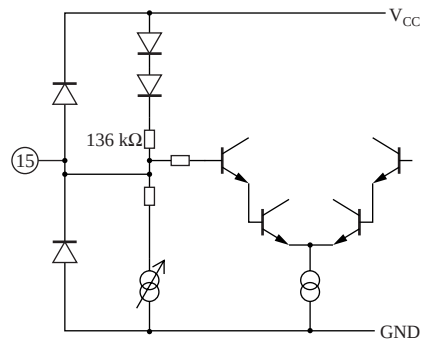
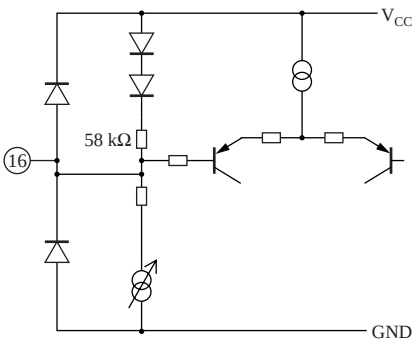
■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	DC voltage (V)
4		OFCAN1: 75 µs filter output Offset cancel pin	2.2
5		OFCAN2: dbx output Offset cancel pin	2.2
6		WBTIME: Wide expander effective value detection recovery time set-up pin	2.2
7	—	V_{CC}: V_{CC} pin	V_{CC}
8		WBDET: RMS detection circuit input pin of wide band expander	2.2

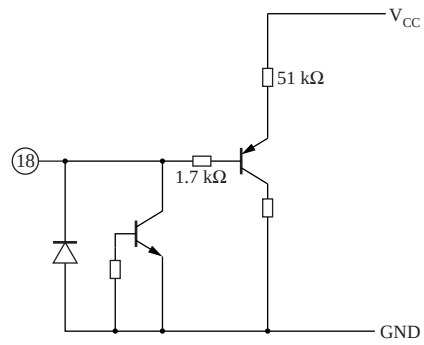
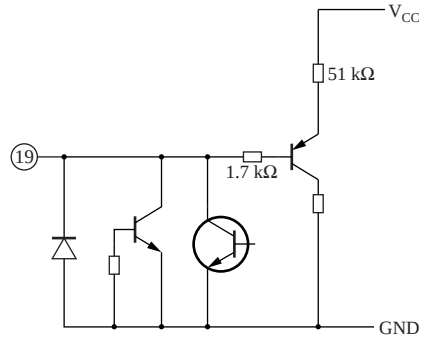
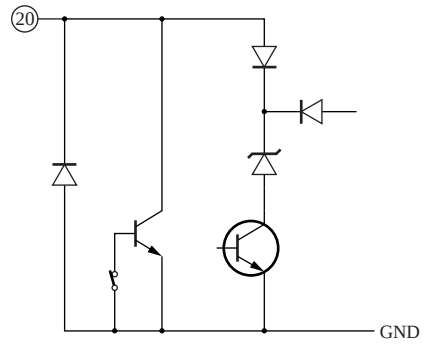
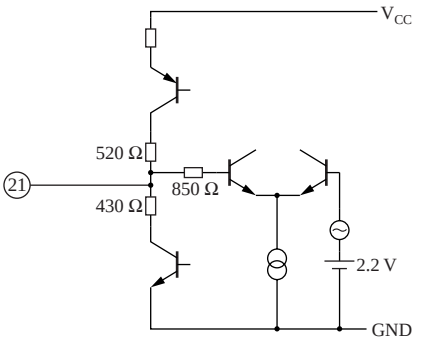
■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	DC voltage (V)
9		SPEFIL: Variable de-emphasis level adjusting pin	2.2
10		SPETIME: RMS detection recovery time pin of variable de-emphasis	0.2
11		SPEDET: RMS detection circuit input pin of variable de-emphasis	2.2
12		NOISEDET: Noise detecting pin of SAP malfunction-prevention-circuit(Mute SAP demodulation at detecting noise.)	$V_{CC} - 2\ V_{BE}$

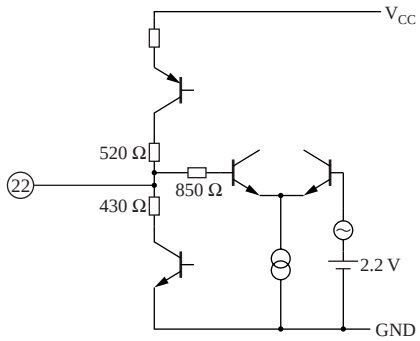
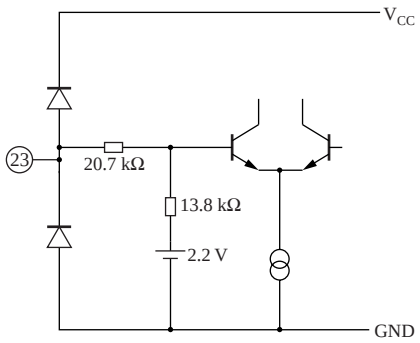
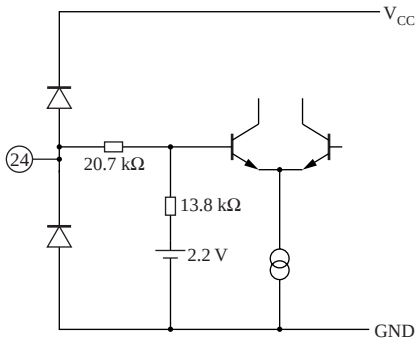
■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	DC voltage (V)
13		SAPDET: SAP signal carrier level detection pin	$V_{CC} - 2\ V_{BE}$
14		MPXIN: Composite signal input pin	2.2
15		PILOTDET: Stereo pilot signal detection pin	$2.2V_{CC} - 2\ V_{BE}$
16		PLL: Stereo PLL low pass filter connection pin	$V_{CC} - 2\ V_{BE}$
17	—	GND: GND pin	0

■ Terminal Equivalent Circuits (continued)

Pin No.	Equivalent circuit	Description	DC voltage (V)
18		SCL: I²C bus clock input pin	—
19		SDA: I²C bus data input pin	2.2
20		PE: Current application input pin for ZAP at final test	—
21		L-OUT: L-ch. line out output pin	2.2

■ Terminal Equivalent Circuits (continued)

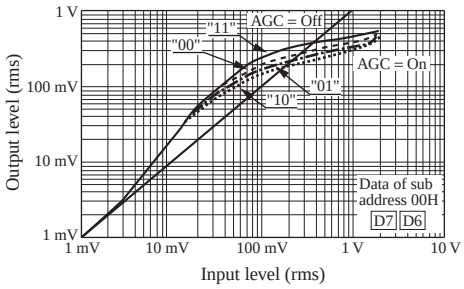
Pin No.	Equivalent circuit	Description	DC voltage (V)
22		R OUT: R-ch. line out output pin	2.2
23		AUX2R: External input 2 L-ch. input pin	2.2
24		AUX2L: External input 2 R-ch. input pin	2.2

■ Usage Notes

1. AGC set-up method

By turning on AGC, the AGC performs 0 dB at a small signal input, Boost at a medium signal and gain reduction at a big signal. It can also control the I/O characteristics of AGC by I²C as shown below:

AGC characteristics



2. Guarantee of I²C operating temperature

I²C bus control operation at an operating ambient temperature is theoretially guranteed based on IC design by means of the inspection using about 50% faster clock speed at the normal temperature (T_a = 25°C).

Namely it is a theoretical value based on IC design, therefore it is not guranteed at the shipping inspection because the inspection under a high and low temperature is not conducted.

3. Electrostatic breakdown

Pay attention to the following levels:

Pin 6: 200 pF, 130 V

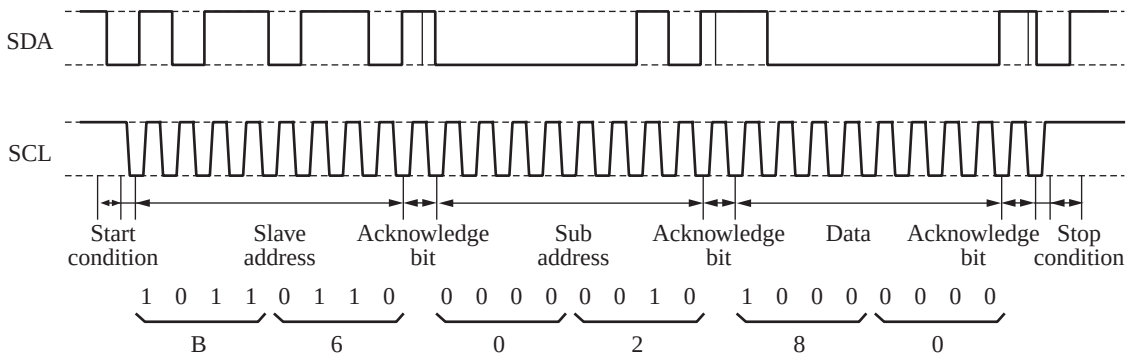
Pin 10: 200 pF, 150 V

Pin 22: 200 pF, 190 V

■ Technical Information

[1] I²C bus

1. Receiving mode



Transmission message

As transfer messages, SCL and SDA are transfered synchronouslly and serially. SCL is a constant clock frequency and SDA is address data for controlling a receiving side and is sent in parallel by synchronizing with SCL. Data are in principle sent by 8-bit 3-octet (byte) and there exists an acknowledge bit per octet. The frame structure is mentioned below:

1) Start condition
   When SDA becomes from high to low at SCL = high, the receiver gets ready to receive.
2) Stop condition
   When SDA becomes from low to high at SCL = high, the receiver stops receiving.
3) Slave address
   Specified for each device. If any addresses of other devices are sent, receiving will be stopped.
4) Sub-address
   Specified for each function.
5) Data
   Data for controlling
6) Acknowledge bit
   This is the bit that informs the master of data reception every octet. The master sends the high signal and the receiver sends back the low signal as shown with the dotted line in the above figure, thus the master acknowledges reception on the receiver side. If the low signal is not sent back, the reception will be stopped.

Except for the start and stop conditions, SDA does not change at SCL = high.

■ Technical Information

[1] I²C bus (continued)

1. Receiving mode (continued)

<I²C of this IC>

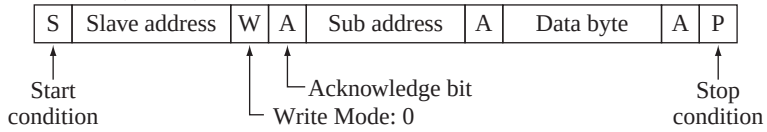
1) Enhances adjustment-free mechanism of the TV set thanks to DAC control 3 and 9 switches

2) Auto-increment function

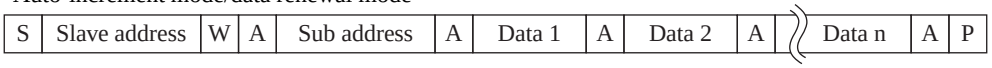
- Sub address 0 *: Auto-increment mode
  (Data sequential transfer leads to the sequential change of sub address, so that the data is inputted.)
- Sub address 8 *: Data renewal mode
  (With sequential data transfer, data are inputted in the same sub address.)

3) I²C bus protocol

- Slave address
- Format (normal)



- Auto-increment mode/data renewal mode



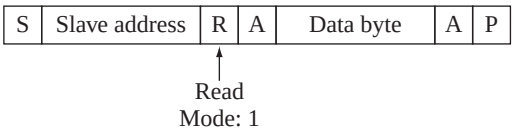
4) As the initial state of DAC is not guaranteed, never fail to input the following data in a power on mode.

"06" register: "04"
"00" register: adjustment data
"01" register: adjustment data
"02" register: "00"
"05" register: adjustment data

2. Transmission mode (read mode)

I²C bus protocol

- Slave address: 10110111 (B7H)
- Format



■ Technical Information (continued)

[1] I²C bus (continued)

• Sub address byte and data byte format

Write mode (slave add.: 10110110)

Sub address	Upper MSB D7	D6	D5	D4	D3	D2	D1	Lower LSB D0
"00"	← AGC adj. →		← Input level adjustment →					
"01"	AUXselect 0: AUX1 1: AUX2	AUX SW 0: Off 1: On	← High frequency separation adjustment →					
"02"	Adj.: 1 → On L:VGA out R:VCO f_H	Mute: 1 → On L: Mute R: Mute	AGC 1 → On	0	FMONO: 1 → On L: L+R R: L+R	0	St/SAP 0 → SAP	(L+R)/SAP 0 → SAP
"05"	*	*	*	*	← Low frequency separation adjustment →			
"06"	*	*	*	*	*	*	0	0

* = Don't care

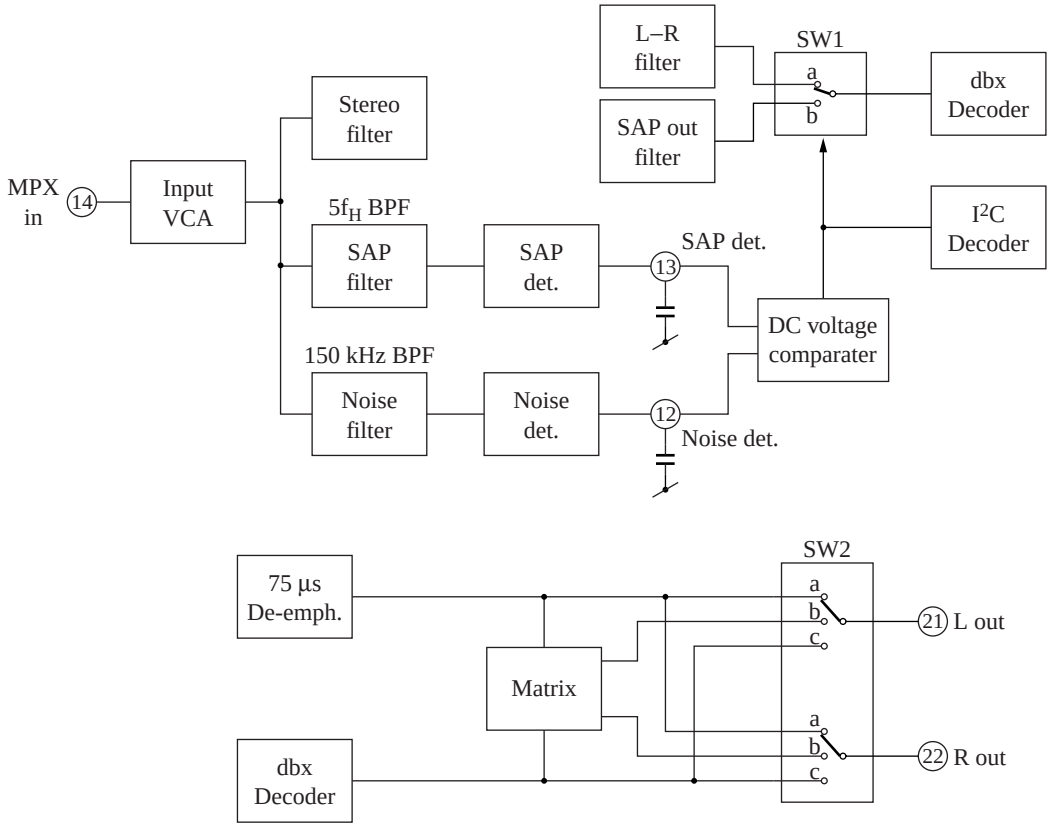
Read mode (slave add.: 10110111)

Upper MSB D7	D6	D5	D4	D3	D2	D1	Lower LSB D0
Pilot det. 1 → DET	SAP det. 1 → DET	*	*	*	*	*	*

* = Don't care

■ Technical Information (continued)

[2] Noise detecting operation in SAP receiving mode



Pin 14 input	"02" register	Pin 12, pin 13 DC voltage	SW1	SW2	I²C SAP det.	Pin 21, pin 22
Noise: Small	"00"	$V_{12} > V_{13}$	b	c	3.5 V to 5 V	SAP
Noise: Large	"00"	$V_{12} < V_{13}$	a	a	0 V to 0.9 V	L+R

■ Application Circuit Example

